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Revision. 2

Transistors with Built-in Resistor

DRC2144G0L

# **Panasonic**

## DRC2144G0L

### Silicon NPN epitaxial planar type

#### For digital circuits

#### ■ Features

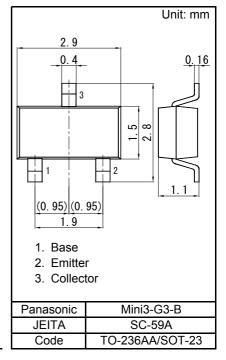
- Low collector-emitter saturation voltage Vce(sat)
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol: NU

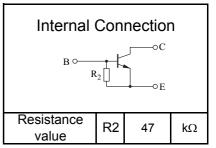
#### ■ Packaging

Embossed type (Thermo-compression sealing): 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Collector-base voltage (Emitter open)	VCBO	50	V
Collector-emitter voltage (Base open)	VCEO	50	V
Collector current	IC	100	mA
Total power dissipation	PT	200	mW
Junction temperature	Tj	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	°C





#### ■ Electrical Characteristics Ta = 25 °C ± 3 °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	VCBO	IC = 10 μA, IE = 0	50			V
Collector-emitter voltage (Base open)	VCEO	IC = 2 mA, IB = 0	50			V
Collector-base cutoff current (Emitter open)	ICBO	VCB = 50 V, IE = 0			0.1	μA
Collector-emitter cutoff current (Base open)	ICEO	VCE = 50 V, IB = 0			0.5	μA
Emitter-base cutoff current (Collector open)	IEBO	VEB = 6 V, IC = 0			2.0	mA
Forward current transfer ratio	hFE	VCE = 10 V, IC = 5 mA	80			-
Collector-emitter saturation voltage	VCE(sat)	IC = 10 mA, IB = 0.5 mA			0.25	V
Input voltage	Vi(on)	VCE = 0.2 V, IC = 5 mA	0.9			V
	Vi(off)	VCE = 5 V, IC = 100 μA			0.4	V
Between emitter base resistance	R2		-30%	47	+30%	kΩ

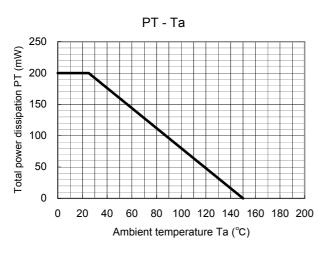
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

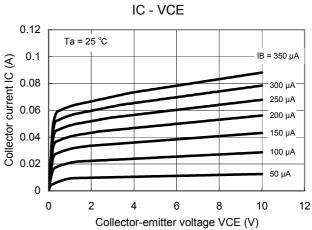
Transistors with Built-in Resistor

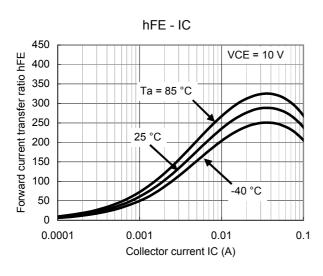
#### DRC2144G0L

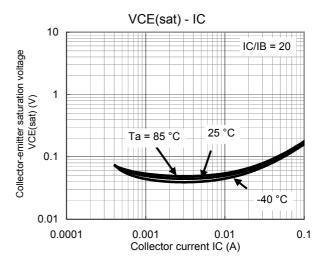
# **Panasonic**

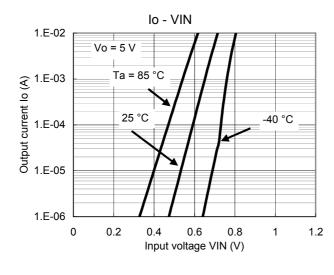
## Technical Data (reference)

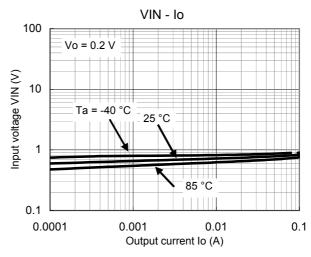












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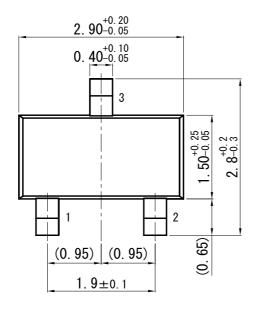
Transistors with Built-in Resistor

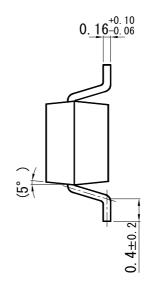
DRC2144G0L

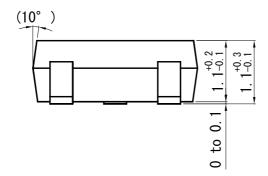
# Mini3-G3-B

**Panasonic** 

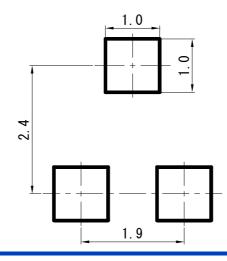
Unit: mm







#### ■ Land Pattern (Reference) (Unit: mm)



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